

CD40257B Types

CMOS Quad 2-Line-to-1-Line Data Selector/Multiplexer

High-Voltage Types (20-Volt Rating)

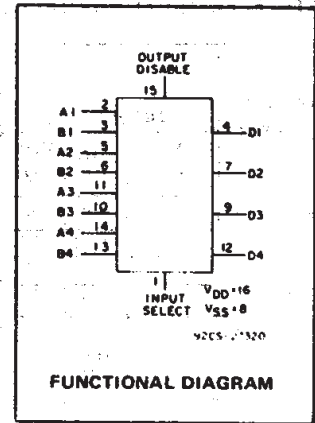
■ CD40257B is a Data Selector/Multiplexer featuring three-state outputs which can interface directly with and drive data lines of bus-oriented systems. The CD40257B types are supplied in 16-lead hermetic dual-in-line ceramic packages (F3A suffix), 16-lead dual-in-line plastic packages (E suffix), 16-lead small-outline packages (M, M96, MT, and NSR suffixes), and 16-lead thin shrink small-outline packages (PW and PWR suffixes).

MAXIMUM RATINGS, Absolute-Maximum Values:

DC SUPPLY-VOLTAGE RANGE, (V _{DD})	
Voltages referenced to V _{SS} Terminal	-0.5V to +20V
INPUT VOLTAGE RANGE, ALL INPUTS	-0.5V to V _{DD} +0.5V
DC INPUT CURRENT, ANY ONE INPUT	±10mA
POWER DISSIPATION PER PACKAGE (P _D):	
For T _A = -55°C to +100°C	500mW
For T _A = +100°C to +125°C	Derate Linearly at 12mW/°C to 200mW
DEVICE DISSIPATION PER OUTPUT TRANSISTOR	
FOR T _A = FULL PACKAGE-TEMPERATURE RANGE (All Package Types)	100mW
OPERATING-TEMPERATURE RANGE (T _A)	-55°C to +125°C
STORAGE TEMPERATURE RANGE (T _{stg})	-65°C to +150°C
LEAD TEMPERATURE (DURING SOLDERING):	
At distance 1/16 ± 1/32 inch (1.59 ± 0.79mm) from case for 10s max	+265°C

Features:

- 3-state outputs
- Standardized, symmetrical output characteristics
- 100% tested for quiescent current at 20 V
- Maximum input current of 1 μA at 18 V over full package-temperature range; 100 nA at 18 V and 25°C
- Noise margin (over full package-temperature range):
 - 1 V at V_{DD} = 5 V
 - 2 V at V_{DD} = 10 V
 - 2.5 V at V_{DD} = 15 V
- 5-V, 10-V, and 15-V parametric ratings
- Meets all requirements of JEDEC Tentative Standard No. 13A, "Standard Specifications for Description of 'B' Series CMOS Devices"



Applications:

- Digital Multiplexing
- Shift-right/shift-left registers
- True/complement selection

RECOMMENDED OPERATING CONDITION

For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges:

CHARACTERISTIC	LIMITS		UNITS
	Min.	Max.	
Supply-Voltage Range (For T _A =Full Package-Temperature Range)	3	18	V

TRUTH TABLE

3-STATE OUTPUT DISABLE	INPUTS		D
	SELECT	A B	
1	X	X X	Z
0	0	0 X	0
0	0	1 X	1
0	1	X 0	0
0	1	X 1	1

X = DON'T CARE LOGIC 1 = HIGH
LOGIC 0 = LOW Z = HIGH IMPEDANCE

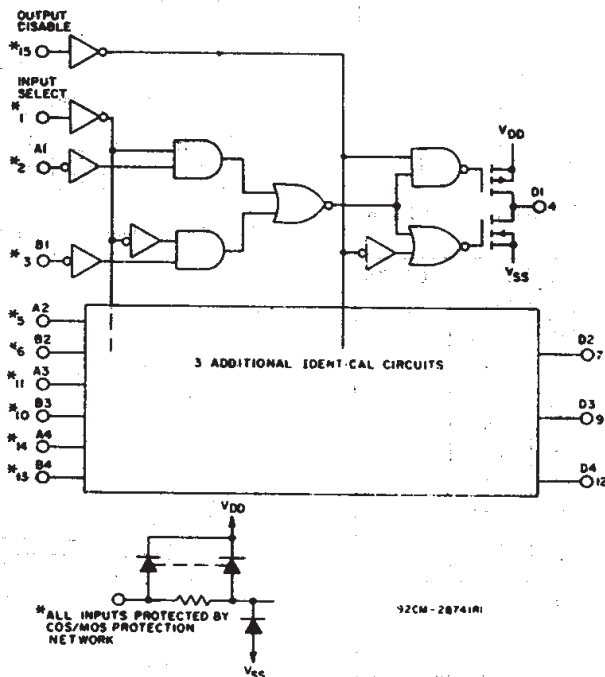


Fig. 1 - Logic diagram for CD40257B.

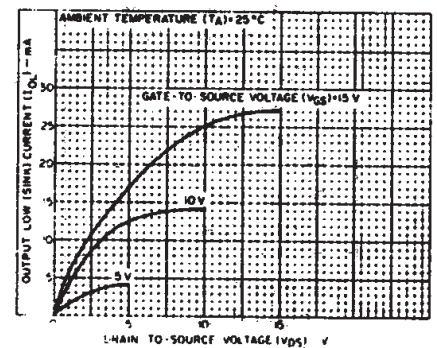


Fig. 2 - Typical output low (sink) current characteristics.

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STATIC ELECTRICAL CHARACTERISTICS

CHARACTERISTIC	CONDITIONS			LIMITS AT INDICATED TEMPERATURES (°C)							UNITS	
	V _O (V)	V _{IN} (V)	V _{DD} (V)	-55	-40	+85	+125	+25				
								Min.	Typ.	Max.		
Quiescent Device Current I _{DD} Max.	-	0.5 0.10 0.15 0.20	5 10 15 20	1 2 4 20	1 2 4 20	30 60 120 600	30 60 120 600	-	0.02 0.02 0.02 0.04	1 2 4 20	μA	
Output Low (Sink) Current, I _{OL} Min.	0.4 0.5 1.5	0.5 0.10 0.15	5 10 15	0.64 1.6 4.2	0.61 1.5 4	0.42 1.1 2.8	0.36 0.9 2.4	0.51 1.3 3.4	1 2.6 6.8	-	-	mA
Output High (Source) Current, I _{OH} Min.	4.6 2.5 9.5 13.5	0.5 0.5 0.10 0.15	5 5 10 15	-0.64 -2 -1.6 -4.2	-0.61 -1.8 -1.5 -4	-0.42 -1.3 -1.1 -2.8	-0.36 -1.15 -0.9 -2.4	-0.51 -1.6 -1.3 -3.4	-1 -3.2 -2.6 -6.8	-	-	mA
Output Voltage: Low-Level, V _{OL} Max.	-	0.5 0.10 0.15	5 10 15	0.05			-			0 0 0	0.05	V
Output Voltage: High-Level, V _{OH} Min.	-	0.5 0.10 0.15	5 10 15	4.95			4.95			5 10 15	-	V
Input Low Voltage, V _{IL} Max.	0.5, 4.5 1.9	-	5 10 15	1.5			-			1.5 3 4	V	
Input High Voltage, V _{IH} Min.	0.5, 4.5 1.9 1.5, 13.5	-	5 10 15	3.5			3.5			- 7 11	V	
Input Current, I _{IN} Max.	-	0.18	18	±0.1	±0.1	±1	±1	-	±10 ⁻⁵	±0.1	μA	
3-State Output Leakage Current I _{OUT} Max.	-	0.18	18	±0.4	±0.4	±12	±12	-	±10 ⁻⁴	±0.4	μA	

DYNAMIC ELECTRICAL CHARACTERISTICS at T_A = 25°C; Input t_r, t_f = 20 ns, C_L = 50 pF, R_L = 200 KΩ

CHARACTERISTIC	TEST CONDITIONS	LIMITS		UNITS	
		V _{DD} (V)	Typ.		Max.
Propagation Delay Time: Data Input to Output, t _{PHL} , t _{PLH}		5	150	300	ns
		10	70	140	
		15	50	100	
Select to Output, t _{PHL} , t _{PLH}		5	190	380	ns
		10	85	170	
		15	65	130	
Output Disable to Output, t _{PHL} , t _{PLH}		5	95	190	ns
		10	50	100	
		15	40	80	
Transition Time, t _{THL} , t _{TLH}		5	100	200	ns
		10	50	100	
		15	40	80	
Input Capacitance, C _{IN}	Any Input	-	5	7.5	pF

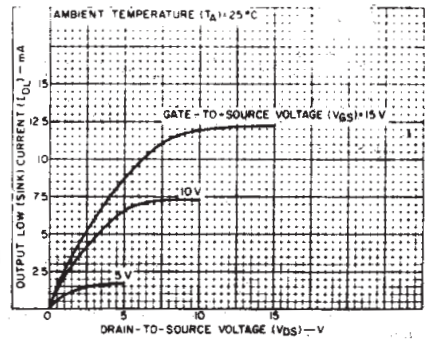


Fig.3 - Minimum output low (sink) current characteristics.

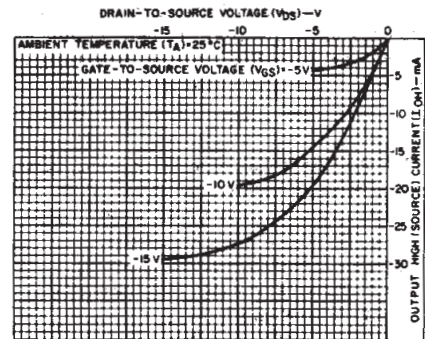


Fig.4 - Typical output high (source) current characteristics.

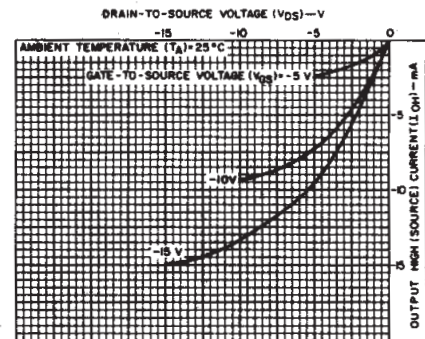


Fig.5 - Minimum output high (source) current characteristics.

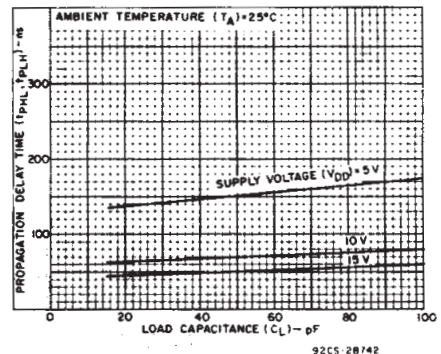


Fig.6 - Typical propagation delay time as a function of load capacitance (DATA INPUT to OUTPUT).

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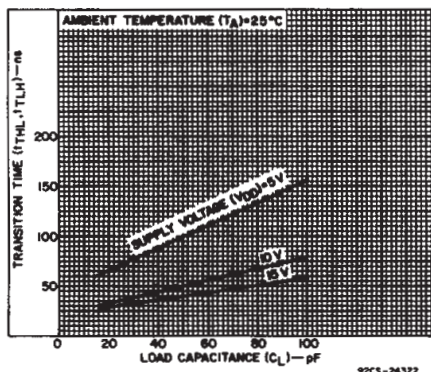


Fig.7 - Typical transition time as a function of load capacitance.

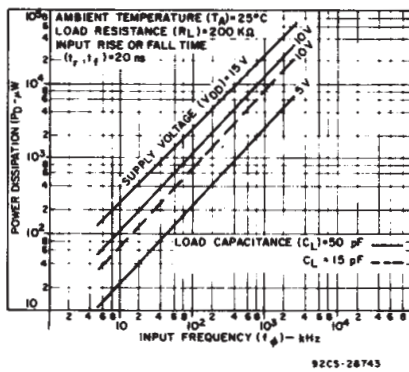


Fig.8 - Typical dynamic power dissipation as a function of input frequency (one INPUT to one OUTPUT).

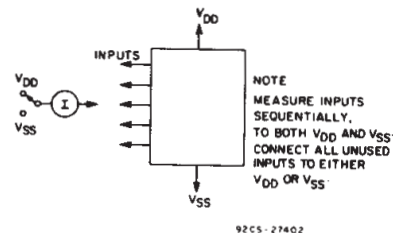


Fig.9 - Input current test circuit.

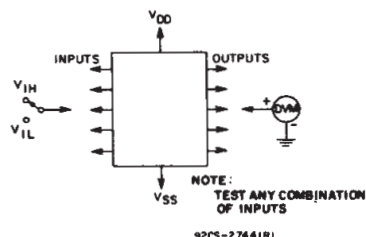


Fig.10 - Input voltage test circuit.

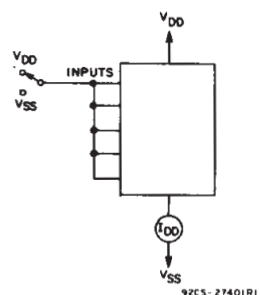
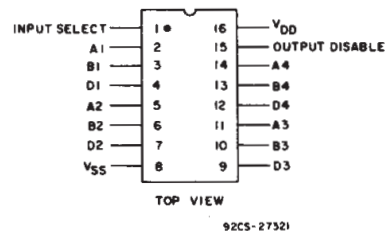
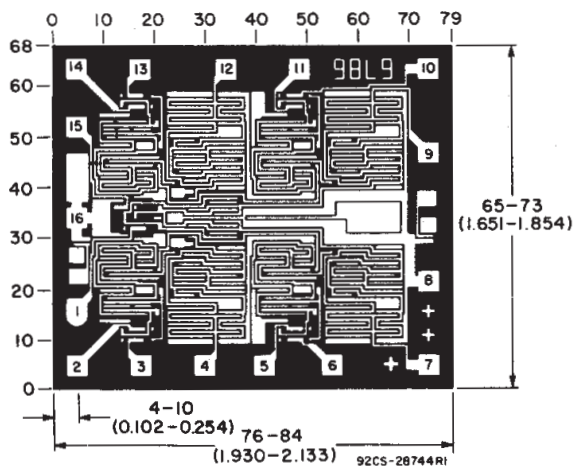


Fig.11 - Quiescent device current test circuit.



TERMINAL ASSIGNMENT

Dimensions and pad layout for CD40257BH.



Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils (10⁻³ inch).

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PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
CD40257BE	Active	Production	PDIP (N) 16	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	-55 to 125	CD40257BE
CD40257BE.A	Active	Production	PDIP (N) 16	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	-55 to 125	CD40257BE
CD40257BEE4	Active	Production	PDIP (N) 16	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	-55 to 125	CD40257BE
CD40257BF3A	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	CD40257BF3A
CD40257BF3A.A	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	CD40257BF3A
CD40257BM	Active	Production	SOIC (D) 16	40 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	CD40257BM
CD40257BM.A	Active	Production	SOIC (D) 16	40 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	CD40257BM

(1) **Status:** For more details on status, see our [product life cycle](#).

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "-" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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OTHER QUALIFIED VERSIONS OF CD40257B, CD40257B-MIL :

- Catalog : [CD40257B](#)
- Military : [CD40257B-MIL](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Military - QML certified for Military and Defense Applications

TUBE


*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
CD40257BE	N	PDIP	16	25	506	13.97	11230	4.32
CD40257BE	N	PDIP	16	25	506	13.97	11230	4.32
CD40257BE.A	N	PDIP	16	25	506	13.97	11230	4.32
CD40257BE.A	N	PDIP	16	25	506	13.97	11230	4.32
CD40257BEE4	N	PDIP	16	25	506	13.97	11230	4.32
CD40257BEE4	N	PDIP	16	25	506	13.97	11230	4.32
CD40257BM	D	SOIC	16	40	507	8	3940	4.32
CD40257BM.A	D	SOIC	16	40	507	8	3940	4.32

D (R-PDSO-G16)

PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
 - D. Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
 - E. Reference JEDEC MS-012 variation AC.

J (R-GDIP-T**)

14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



DIM \ PINS **	14	16	18	20
A	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC
B MAX	0.785 (19,94)	.840 (21,34)	0.960 (24,38)	1.060 (26,92)
B MIN	—	—	—	—
C MAX	0.300 (7,62)	0.300 (7,62)	0.310 (7,87)	0.300 (7,62)
C MIN	0.245 (6,22)	0.245 (6,22)	0.220 (5,59)	0.245 (6,22)



4040083/F 03/03

- NOTES:
- All linear dimensions are in inches (millimeters).
 - This drawing is subject to change without notice.
 - This package is hermetically sealed with a ceramic lid using glass frit.
 - Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
 - Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
 - The 20 pin end lead shoulder width is a vendor option, either half or full width.

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